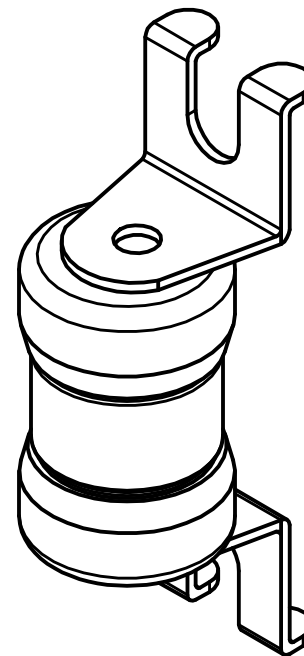
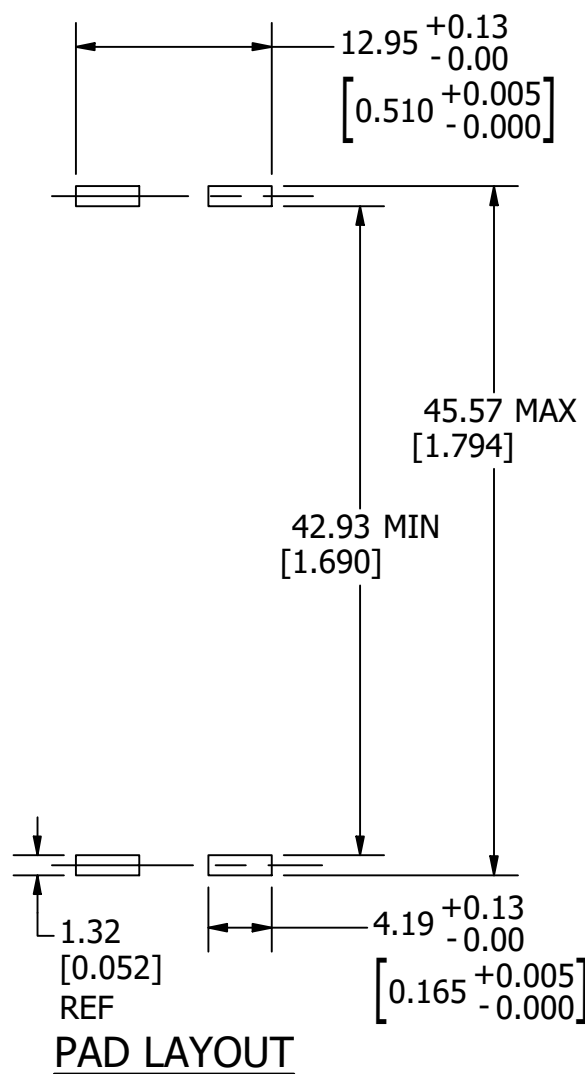
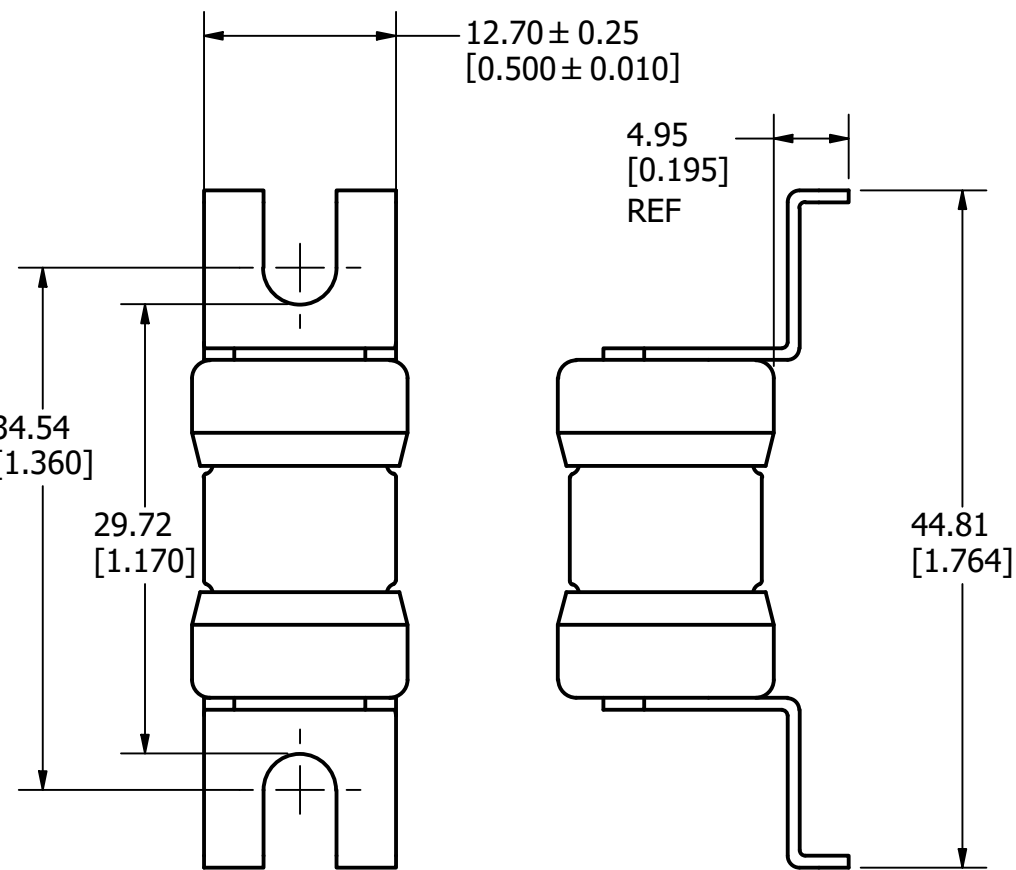




LEAD-FREE SOLDERING PROFILE:

PRE-HEAT: ABOVE 130°C FOR 75 SECONDS MAX.
REFLOW: 278°C FOR 8 SECONDS MAX.
TIME: 250 SECONDS MAX.
MAX. TEMP: 280°C

REVISION				
REV	DATE	DESCRIPTION		
A	5/8/19	520782GCP - RELEASE MRY		
B	5/14/20	522325ECP/D - ADD FRONT VIEW MRY		

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